
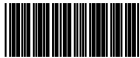


## APPLICATION DATA SHEET

Electronic Version v14

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| <b>Title of Invention</b>  | TWO-SIDED CHEMICAL MECHANICAL POLISHING PAD FOR SEMICONDUCTOR PROCESSING |  |  |
| Application Type : regular, utility<br>Attorney Docket Number : FIS920030277   |  |  |  |
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